

***TLV320AIC12KEVM,
TLV320AIC14KEVM***

User's Guide

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During normal operation, some circuit components may have case temperatures greater than 30°C. The EVM is designed to operate properly with certain components above 40°C as long as the input and output ranges are maintained. These components include but are not limited to linear regulators, switching transistors, pass transistors, and current sense resistors. These types of devices can be identified using the EVM schematic located in the EVM User's Guide. When placing measurement probes near these devices during operation, please be aware that these devices may be very warm to the touch.

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Preface

Read This First

About This Manual

This users guide describes the operation and use of the TLV320AIC12K codec family. A complete circuit description, schematic diagram, and bill of materials are also included.

How to Use This Manual

This document contains the following chapters:

- ☐ Chapter 1—EVM Overview
- ☐ Chapter 2—Digital Interface
- ☐ Chapter 3—Analog Interface
- ☐ Chapter 4—EVM Operation
- ☐ Chapter 5—TLV320AIC12KEVM/14KEVM Bill of Materials
- ☐ Appendix A—TLV320AIC12KEVM/14KEVM Schematic

FCC Warning

This equipment is intended for use in a laboratory test environment only. It generates, uses, and can radiate radio frequency energy and has not been tested for compliance with the limits of computing devices pursuant to subpart J of part 15 of FCC rules, which are designed to provide reasonable protection against radio frequency interference. Operation of this equipment in other environments may cause interference with radio communications, in which case the user at his own expense will be required to take whatever measures may be required to correct this interference.

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Data Sheets:

TLV320AIC12K
TLV320AIC14K

Literature Number:

SLWS115
SLWS115

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EVM Overview

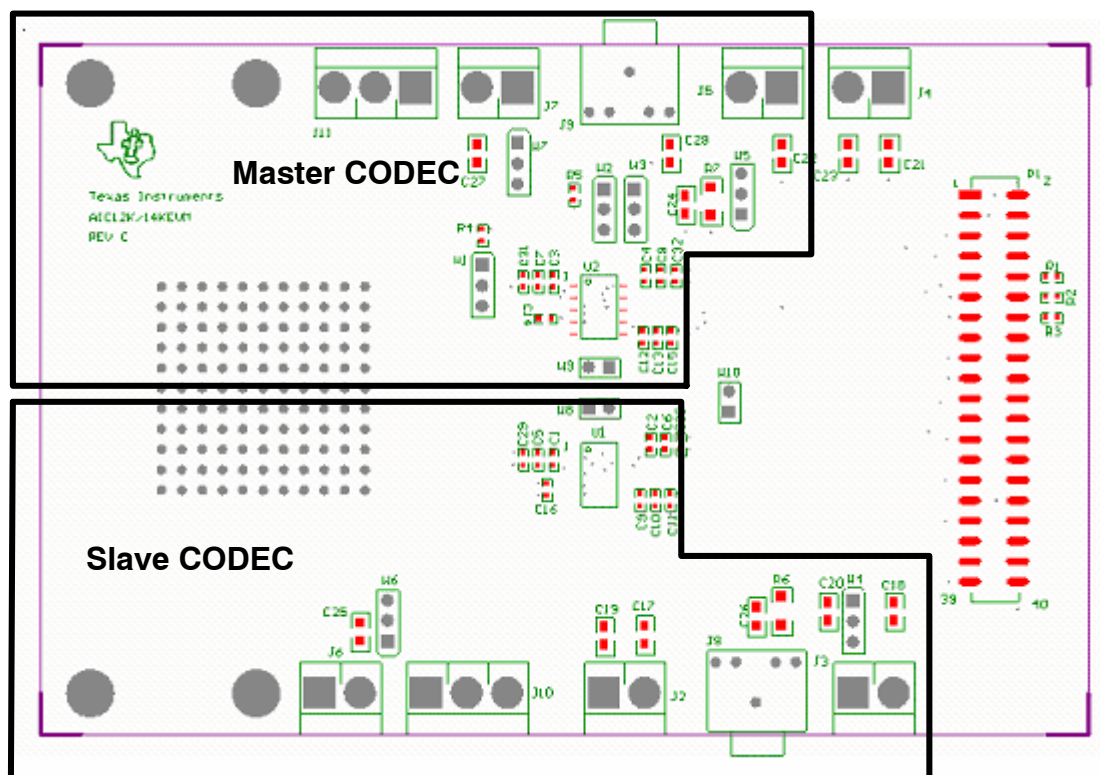
This user's guide supports the following devices:

- ☐ TLV320AIC12K
- ☐ TLV320AIC14K

This guide refers to the TLV320AIC12K only, since the remaining device feature set is a subset of the TLV320AIC12K. Any important differences are noted.

Figure 1–1. EVM

The EVM is split into two complementary halves as shown in Figure 1–1.



Digital Interface

The digital signals required to operate this codec originate from the 40-pin connector—J1. There are two methods to drive the digital interface:

- ☐ Create a custom interface between the codec EVM and the host system.
- ☐ Alternatively, if a TI DSK (DSP starter kit) is the host system, a development platform is available from TI. This platform provides the additional functions that the codec requires in a convenient form factor.

Topic	Page
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2.1 Codec-to-Platform

The TLV320AIC12K, and 14K mate with the development platform via a 40-pin Samtec connector. The mating connector (Samtec part number, TSM-120-01-T-DV-P) is used on the development platform to provide the electrical connections necessary. Consult Samtec at www.samtec.com or 1-800-SAMTEC-9 for more information.

The pinout for the 40-pin connector is listed in Table 2-1.

Table 2-1. Pinout for 40-Pin Connector

Pin Number	Signal	Description
J1.1	MCLK	Master clock
J1.2	DGND	Digital ground
J1.3	SCLK	Serial data clock
J1.4	DGND	Digital ground
J1.5	DIN	Data in
J1.6	DGND	Digital ground
J1.7	DOUT	Data out
J1.8	Reserved	Reserved for future use
J1.9	FS	Frame sync
J1.10	Reserved	Reserved for future use
J1.11	CLKX	Transmit clock
J1.12	Reserved	Reserved for future use
J1.13	FSX	Frame sync transmit
J1.14	Reserved	Reserved for future use
J1.15	DX	Data transmit
J1.16	DR	Data receive
J1.17	RESET	Global reset for all devices
J1.18	FSR	Frame sync receive
J1.19	PWDN	Global powerdown for all devices
J1.20	CLKR	Receive clock
J1.21	CNTLb	GPIO pin
J1.22	CNTLa	GPIO pin
J1.23	STATb	Status pin
J1.24	STATa	Status pin
J1.25	3.3V_D	Digital 3.3 V
J1.26	Reserved	Reserved for future use
J1.27	3.3V_D	Digital 3.3 V
J1.28	DGND	Digital ground
J1.29	1.8V_D	Digital 1.8 V
J1.30	DGND	Digital ground
J1.31	1.8V_D	Digital 1.8 V
J1.32	DGND	Digital ground

Table 2–1. Pinout for 40-Pin Connector (Continued)

Pin Number	Signal	Description
J1.33	3.3V_A_DRV	Output driver supply 3.3 V
J1.34	AGND	Analog ground
J1.35	3.3V_A_DRV	Output driver supply 3.3 V
J1.36	AGND	Analog ground
J1.37	3.3V_A	Analog 3.3 V
J1.38	AGND	Analog ground
J1.39	3.3V_A	Analog 3.3 V
J1.40	AGND	Analog ground

The development platform supports a number of functions that the codecs require. These are:

- ☐ MCLK generation
- ☐ Manual reset generation
- ☐ Power options

Refer to the *DSP – Codec Development Platform User's Guide* (SLAU090) for details regarding the development platform.

Further descriptions regarding the operation of this EVM assumes that the development platform is being used for all additional signals and power.

2.2 Jumper Options

There are various jumpers on the board that can be configured in various ways, depending upon the user's requirements. Their functions are briefly presented in Table 2–2:

Table 2–2. Jumper Options

Jumper	Function
W1	Selects whether U2 is either a master or a slave codec
W2	Used along with W2 for correct polarity for FSD
W3	Manages FSD from the master. Either connecting FSD to next co-dec or providing relevant polarity.
W4	Source for INM1b
W5	Source for INM1a
W6	Coupling for OUTP1b. Either directly or via capacitor.
W7	Coupling for OUTP1a. Either directly or via capacitor.
W8	Connects analog and digital ground together
W9	Gives user the option of disconnecting the 3.3-V driver ground from the regular analog ground
W10	Use for odd number codec channels. Isolate the data from the co-dec not participating in the chain.
P1.9–P1.10	Last FSD in the chain must be high
P1.11–P1.12	SCL must be high
P1.13–P1.14	SDA must be high

Since the EVM contains two codecs, there a variety of options available to the user:

- ☐ Stand-alone slave codec
- ☐ Single master codec
- ☐ Master/slave cascade

Each of these options are discussed in the following sections.

2.2.1 Stand-Alone Slave

This configuration applies to EVM1 only. When a single codec is to be used in slave mode, U2 is always the slave codec. Follow the jumper settings detailed in Table 2–3 for this condition.

Table 2–3. Stand-Alone Slave Jumper Settings

Jumper	1–2	2–3
W1	Not inserted	Inserted
W2	Inserted	Not inserted
W3	Inserted	Not inserted
W4	Not inserted	Inserted
P1.9–P1.10	N/A	N/A
P1.11–P1.12	Inserted	Inserted
P1.13–P1.14	Inserted	Inserted

2.2.2 Single Master Only

This configuration applies to EVM1 only. When a single codec is to be used in master mode, U2 is always the master codec. Follow the jumper settings detailed in Table 2–4 for this condition.

Table 2–4. Single Master Only Jumper Settings

Jumper	1–2	2–3
W2	Inserted	Not inserted
W3	Inserted	Not inserted
W4	Inserted	Not inserted
P1.9–P1.10	N/A	N/A
P1.11–P1.12	Inserted	Inserted
P1.13–P1.14	Inserted	Inserted

2.2.3 Master/Slave Cascade

This configuration applies to EVM1 only and is the factory-set shipping condition. When both codecs are used, both U1 and U2 are active. In this condition U2 is always the master codec, and U1 is always the slave codec. Follow the jumper settings detailed in Table 2–5.

Table 2–5. Master/Slave Cascade Jumper Settings

Jumper	1–2	2–3
W1	Inserted	Not inserted
W2	N/A	N/A
W3	Not inserted	Inserted
W4	Inserted	Inserted
P1.9–P1.10	Inserted	Inserted
P1.11–P1.12	Inserted	Inserted
P1.13–P1.14	Inserted	Inserted

Analog Interface

Table 3–1 indicates the applicable connectors for each codec in the family. In order to enable a wide range of sources and loads to be connected to the codecs, screw terminals have been used wherever possible.

Table 3–1. Analog Interface Connectors

	TLV320AIC12K		TLV320AIC14K	
	Master	Slave	Master	Slave
Input Sources				
Microphone input	J9	J8	J9	J8
INP1	J5	J3	J5	J3
INP2	J4	J2	J4	J2
Output Loads				
OUTP1/OUTM1 600- Ω line output	J7	J6	J7	J6
OUTP2/OUTP3 16- Ω driver output	J11	J10	NA	

EVM Operation

The EVM is shipped from the factory in master/slave cascade mode. To check if the EVM is working properly, simply install the EVM onto the development platform, and apply power to the DSK. The EVM should begin working immediately.

In the default mode, the codecs recognize that there are two channels connected in the master/slave configuration, consequently the resultant SCLK and FS signals transmitted by the master codec adjust automatically based on the available MCLK.

It is now possible to calculate what should be observed after power up by calculating what FS and SCLK should be observed:

☐ FS

- In this example, MCLK is generated by the development platform and is equal to 100 MHz.
- $FS = MCLK / 16 \times m \times n \times p$
- Default values for m, n, and p are 16, 6, and 8 respectively
- $FS = 100 \times 10^6 / 16 \times 16 \times 6 \times 8$
- $FS = 8138 \text{ Hz}$

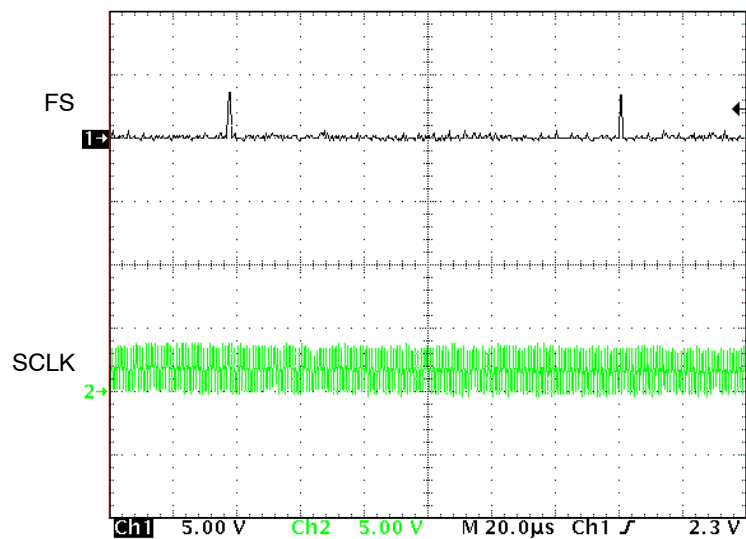
☐ SCLK

- $SCLK = 16 \times FS \times (\text{number of devices}) \times \text{mode}$
- $SCLK = 16 \times 8138 \times 2 \times 1$
- $SCLK = 260 \text{ kHz}$

FS can be observed either directly at the FS pin of U1 or U2 (pin 4) or on the development platform at TP9. SCLK can be observed easily at P1 pin 3 of the EVM or on the development platform at TP8.

The captured signals are shown in Figure 4-1.

Figure 4-1. EVM Captured Signals



TLV320AIC12K/14K Bill of Materials

The following table contains a complete bill of materials for the TLV320AIC12K/14K family of EVMs. The schematic diagram is also provided for reference. Contact the Product Information Center or e-mail dataconvapps@list.ti.com for questions regarding this EVM.

Used	Value	Ref Des	Description	Vendor	Part number
4	0.01 μ F	C29 C30 C31 C32	Capacitor 10000-pF 50-V ceramic Y5V 0603	Panasonic	ECJ-1VF1H103Z
12	0.1 μ F	C5 C6 C7 C8 C9 C10 C11 C12 C13 C14 C15 C16	Capacitor 0.1- μ F 25-V ceramic Y5V 0603	Panasonic	ECJ-1VF1E104Z
16	0.1 μ F	C17 C18 C19 C20 C21 C22 C23 C24 C25 C26 C27 C28	Capacitor 0.1- μ F 50-V ceramic X7R 0805	Panasonic	ECJ-2YB1H104K
4	1 μ F	C1 C2 C3 C4	Capacitor 1- μ F 10-V ceramic Y5V 0603	Panasonic	ECJ-1VF1A105Z
5	10 k Ω	R1 R2 R3 R4 R5	Resistor 10-k Ω 1/16-W 5% 0603 SMD	Panasonic	ERJ-3GEYJ103V
2	10 k Ω	R6 R7	Resistor 10.0-k Ω 1/8-W 1% 1206 SMD	Panasonic	ERJ-8ENF1002V
2		U1 U2 *	IC CODEC 1CH 16-bit 3.3-V 30 TSSOP	Texas Instruments	TLV320AIC12KIDBT
	* Alternate		IC CODEC 1CH 16-bit 3.3-V 30 TSSOP	Texas Instruments	TLV320AIC14KIDBT
1			TLV320AIC12 PWB	Texas Instruments	6435621
1		J1	40-Pin SMT socket	Samtec	SSW-120-22-F-D-VS-K
1		P1	40-Pin SMT plug	Samtec	TSM-120-01-T-DV-P
6		J2 J3 J4 J5 J6 J7	2 Terminal screw connector	Lumberg	KRMZ2
2		J10 J11	3 Terminal screw connector	Lumberg	KRMZ3
2		J8 J9	161-3504	Mouser	161-3504
3		W8 W9 W10	2 Position jumper	Samtec	TSW-102-07-L-S
7		W1 W2 W3 W4 W5 W6 W7	3-Position jumper	Samtec	TSW-103-07-L-S
2		See Assy Dwg	1.000/4-40 Nylon hex thread SP	Keystone Electronics	1902E

Used	Value	Ref Des	Description	Vendor	Part number
2		See Assy Dwg	0.500/4-40 Nylon hex thread SP	Keystone Electronics	1902C
2		See Assy Dwg	4-40 X 1/4 Machine screw PH SS	Building Fasteners	PMSSS 440 0025 PH

TLV320AIC12K/14K EVM Schematic

The TLV320AIC12K/14K EVM schematics are provided on the following pages.

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